

In-situ TEM observation of electron irradiation induced shape transition of elongated gold nanoparticles embedded in silica

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ABSTRACT

Elongated Au nanoparticles (NPs) embedded in silica matrix were fabricated by 100 MeV Ag ion irradiation of 3 MeV Au ion implanted SiO₂/Si(100) substrates, annealed at 1050°C. Electron-beam-induced shape evolution of elongated Au NPs embedded in SiO₂ has been studied by high resolution transmission electron microscopy. Electron beam irradiation resulted in a decrease in the aspect ratio of Au NPs from ~ 1.4 to 1 with increase in irradiation time. The observed ellipsoidal-to-spherical shape transition of Au NPs has been ascribed mainly to the cumulative effects of electron beam induced heating, softening of silica matrix and radiation enhanced diffusion of knock-on displaced O and Si atoms, resulting in local stress relaxation. Copyright © 2013 VBRI press.

Keywords: Gold nanoparticles; electron beam; transmission electron microscopy.



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Devesh Kumar Avasthi is Group Leader for materials science and radiation biology at Inter University Accelerator Centre, New Delhi. He implemented elastic recoil detection analysis (ERDA) technique for light element depth profiling. Later a gaseous telescope detector was designed, fabricated and installed to enhance the capabilities of ERDA, which was used for electronic sputtering measurements. The facilities for thin film development and vacuum laboratory were developed to take care

of need of accelerator. The most recent developments of his group have been an atom beam sputtering set up for synthesis of nanocomposite thin films, in-situ ERDA, in-situ XRD, in-situ QMA in beam line. His main interest is ion beams for analysis, modification of materials, synthesis and engineering the nanostructures by ion beams. Currently his interest has been creation and modification of nanostructures by ion beams. He had major research projects under 'Intensifying Research in High Priority Area' scheme and currently a project under 'Nano Mission' funded by Department of Science and Technology, Government of India. Dr. Avasthi had several international collaborations with research groups in Munich, Stuttgart, Kiel, Orsay and Padova. He is a member of international committee for the conferences on 'Ion Beam Analysis' and 'Swift Heavy Ion in Matter'. He has several conference proceedings as editor and more than three hundred research papers to his credit.

Introduction

Metal nanostructures embedded in dielectric matrix exhibit unique physical and chemical properties, widely different from that of bulk. The size and shape dependent properties of metal nanostructures make them promising for a wide range of applications in nanoelectronics, photonics, telecommunications and bio-medical engineering [1-7]. Several physical and chemical methods have been employed for the synthesis of metal nanostructures embedded in various dielectric matrices [8-14]. For their applications in nanotechnology, it is very important to controllably tailor the size and shape of metal nanostructures. Irradiation with energetic ion beams has emerged a unique tool to tailor the shape and size distribution of embedded metal nanoparticles (NPs) [15-20]. Recent studies have shown that electron beam irradiation can also be used for tailoring the size distribution of metal NPs in nanocomposites [21-26]. The effects of electron beam irradiation on the shape and size distribution of embedded NPs is of interest since during TEM measurements the nanocomposites are exposed to energetic electrons. In a recent study [26], we have shown that 200 keV electron beam irradiation of Au-silica nanocomposites leads to controlled growth of Au NPs. However, electron beam irradiation induced shape change of Au NPs have not been reported so far to the best of our knowledge. Electron beam irradiation can cause quasi-melting of small nanoclusters and also result in relaxation of strain in embedded nanostructures leading to their shape change. In this letter, we report an *in-situ* TEM investigation of electron-beam-induced shape evolution of elongated Au NPs embedded in SiO₂ and analyze the mechanisms underlying the shape change. We demonstrate that electron beam irradiation can be used as an effective tool to tailor the shape of Au NPs embedded in SiO₂.

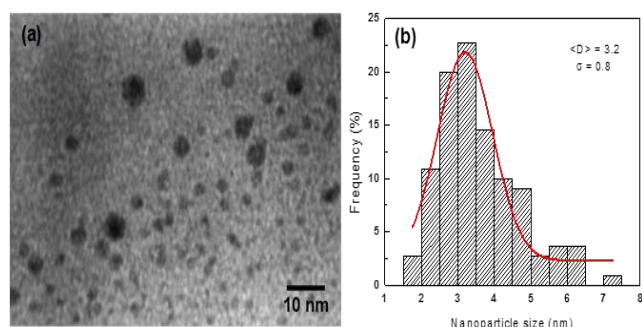


Fig. 1. (a) Cross sectional TEM image of the as-annealed sample. (b) size distribution of Au NPs embedded in SiO₂ film.

Experimental

Amorphous SiO₂ thin films with thickness ~950 nm were grown on Si(100) substrates by wet thermal oxidation. Nanometer-sized Au particles (average size 2 nm) embedded in SiO₂ were synthesized by 3 MeV Au³⁺ ion implantation to a fluence of 6×10^{15} ions cm⁻² followed by annealing in air at 1050°C. Annealed samples were then irradiated with 100 MeV Ag ions to a fluence of 1×10^{14}

ions cm⁻² using 15UD Pelletron accelerator facility at IUAC, New Delhi. The microstructure of the annealed and irradiated sample was studied by cross sectional TEM at 200 keV using JEOL 2010 UHR TEM facility at Institute of Physics, Bhubaneswar. *In-situ* TEM experiments were carried out at 200 keV for investigating the electron-beam-induced shape evolution of Au NPs embedded in SiO₂ film in the irradiated sample. HRTEM studies on Au NPs embedded in SiO₂ were carried out for studying the crystal structure, shape and size of Au NPs. HRTEM images of Au NPs were recorded after every 5 minutes of electron beam irradiation, at the same spot.

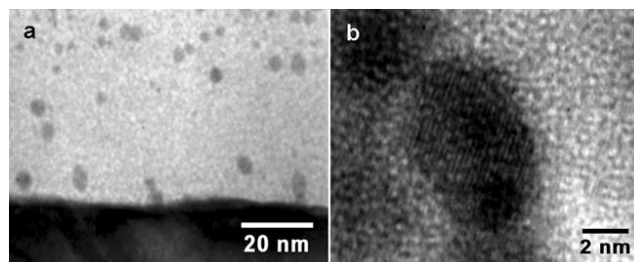


Fig. 2. (a) Cross sectional TEM image of the irradiated sample. (b) HRTEM image of one elongated Au NP embedded in SiO₂ film.

Results and discussion

Fig. 1 (a) shows bright field cross sectional TEM image of the annealed sample before irradiation, which reveals the presence of spherical Au NPs embedded in SiO₂ layer. The size distribution of these Au NPs in the SiO₂ layer is shown in **Fig. 1**(b). The average size of these Au NPs has been found to be $\sim 3.2 \pm 0.8$ nm. In **Fig. 2**(a) we show the bright field cross sectional TEM image of the annealed sample, irradiated with 100 MeV Ag ions to a fluence of 1×10^{14} ions cm⁻². The presence of spherical Au NPs with average size ~ 2 nm together with elongated Au NPs of larger size can be clearly seen. The elongation of Au NPs has been found to be along the ion beam direction. The HRTEM image of one such elongated Au NP is shown as inset in **Fig. 2**(b). The major axis length is 5.5 nm while the minor axis length is 4 nm. The average aspect ratio (ratio of major-to-minor axis length) of elongated Au NPs has been found to be ~ 1.4 . The passage of 100 MeV Ag ions through SiO₂ film containing Au NPs deposits electronic energy (S_e) of ~ 11.1 keV/nm, estimated using stopping range of ions in matter (SRIM) program [27]. This results in the formation of latent tracks of diameter ~ 8 nm in the SiO₂ film [28]. Each individual ion impact leads to the formation of thermal spike of duration $\sim 10^{-12}$ s which results in transient melting and viscous flow of silica [29]. Elongation of Au NPs embedded in silica matrix upon swift heavy ion irradiation has been reported [17-20] and explained in different ways. Roorda et al. [16] have explained the deformation of Au NPs along ion beam direction in ion irradiated Au-silica core-shell nanostructures as a consequence of in-plane mechanical stress on silica shell acting perpendicular to the ion beam [30]. This pressure exerted by silica shell on the radiation softened Au core results in spherical-to-oblate shape transformation of Au NPs along ion beam direction. The second explanation is based on the fact that volume

expansion of Au while transforming from solid to molten state is more than that of silica undergoing similar transformation [20]. This leads to elongation of Au NPs along ion track in which small Au NPs and silica both exist in transiently molten state during thermal spike.

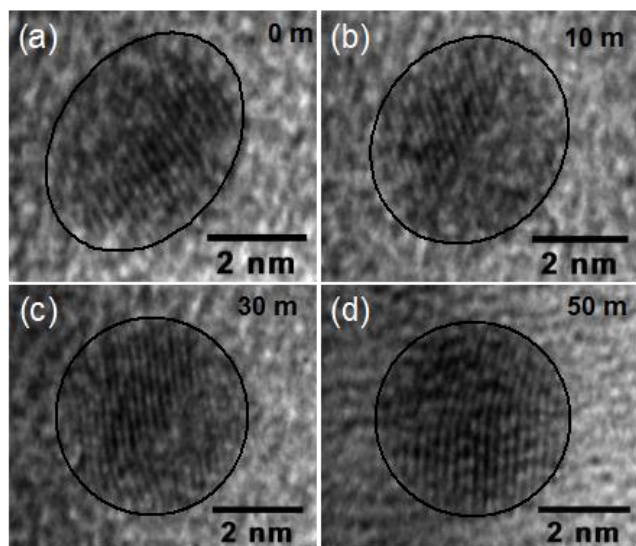


Fig. 3. HRTEM micrographs (a)-(d) showing a typical shape evolution of elongated Au NP embedded in SiO₂ during 200 keV electron beam irradiation. The numbers marked in each micrograph indicate the irradiation time in minutes.

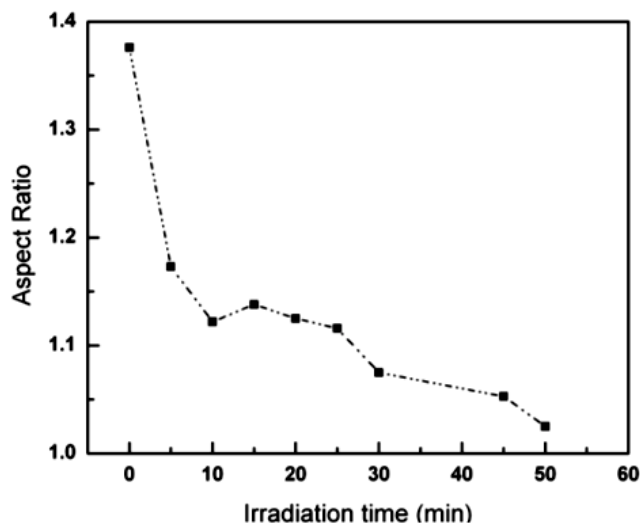


Fig. 4. Variation of aspect ratio of Au NP with electron beam irradiation time. The aspect ratio of Au NP was found to decrease from about 1.4 to 1 during electron beam irradiation.

In **Fig. 3**, we show the results of an *in-situ* HRTEM study on elongated Au NPs embedded in SiO₂. **Fig. 3(a-d)** shows the time dependent HRTEM images revealing the shape evolution of one elongated Au NP, when the electron beam irradiation time is increased from 0 to 50 minutes. The shape change of the elongated Au NP with increase in irradiation time can be clearly seen. The variation of aspect ratio of Au NP with electron irradiation time is shown in **Fig. 4**. The aspect ratio of the Au NP showed a marked decrease from ~ 1.4 to 1 as the irradiation time is increased to 50 min. The observed shape recovery of elongated Au

NP from ellipsoidal-to-spherical shape upon electron beam irradiation has an important significance because it offers a unique way to tailor down the aspect ratio of embedded NPs. The possible mechanisms underlying the observed electron-beam-induced shape evolution of elongated Au NPs embedded in silica matrix are discussed in the next section.

When an energetic electron beam penetrates a solid, electrons undergo elastic scattering with target nuclei and inelastic scattering with atomic electrons. The elastic collisions of incident electrons with target nuclei result in knock-on displacements of target atoms. The inelastic scattering of electrons leads to the excitation or ejection of atomic electrons. The possible mechanisms of atomic-electron excitation include ionization of core electrons, ionization of valence electrons leading to covalent bond breakage, elevation of valence electrons to exciton state and collective excitation of valence electrons into plasmons [31]. The energy deposited by electrons results in an increase in temperature of the irradiated area. The thermal energy deposited by electrons results in melting of small clusters and diffusion of constituent atoms in the irradiated area. This together with the atomic displacements caused due to elastic scattering of electrons can result in change in the size and shape of nanoparticles in the irradiated area. In addition, radiation enhanced atomic diffusion and stress relaxation in embedded NPs due to temperature rise of matrix can lead to change in their size and shape. Therefore, we estimate the temperature rise in the matrix and the atomic displacements caused by incident electrons.

We have theoretically calculated the temperature rise (ΔT_e) in the SiO₂ matrix due to 200 keV electron beam irradiation using the formalism given by Liu and Rishbud [21]. The total energy loss (Q) of the electrons in the solid results in an increase in temperature (ΔT_e) of the matrix. The temperature rise of SiO₂ matrix due to electron beam irradiation for time t_e seconds is given by –

$$\Delta T_e = \frac{3JQ}{8ec_d D} R_e^2 \log \left(1 + \frac{4Dt_e}{R_e^2} \right) \text{-----(1)}$$

where $D = k_t/c_v d$ (k_t is the thermal conductivity, c_v is specific heat and d is the density), $J (=1.4 \times 10^8 \text{ A/m}^2)$ is the current density and R_e is the effective radius of the irradiated area. The rise in temperature (ΔT_e) of the SiO₂ matrix as a function of time (t_e) has been calculated using $k_t = 130 \text{ J/m s K}$, $d = 2200 \text{ Kg/m}^3$, $c_v = 740 \text{ J/Kg K}$ for the SiO₂ matrix. It has been observed that the temperature (ΔT_e) increases up to about 140°C after electron beam irradiation for 50 minutes.

The maximum energy transferred to a nucleus of mass m_a by an electron of mass m_e and kinetic energy E is given by [32]-

$$E_{\max} = \frac{2m_a E(E + 2m_e c^2)}{[(m_a + m_e)^2 c^2 + 2m_a E]} \text{-----(2)}$$

For 200 keV electrons, E_{\max} have been estimated to be 32.8 eV, 18.7 eV and 2.7 eV for O, Si and Au atoms, respectively. The estimated values of E_{\max} for O and Si

atoms are higher than the corresponding displacement energies for O (9.3 eV) and Si (18.6 eV), reported for electron irradiation of SiO₂ films [33]. However, E_{max} for Au is much lower than the corresponding displacement energy of 25 eV. Therefore, 200 keV electron beam irradiation of SiO₂ matrix containing Au NPs results in knock-on displacements of O and Si atoms, but not that of Au atoms. The knock-on displacements of O and Si atoms can result in the relaxation of stress around the elongated Au NPs. It must be pointed out here that the cross sections for electron induced knock-on displacements of O and Si atoms are small. However, electron beam induced radiation enhanced diffusion (RED) of knock-on displaced O and Si atoms and temperature rise of silica have been shown to result in precipitation of Si nanocrystals in silica [34] and shape deformation of nanopores in silica [34]. The shape deformation of silica nanopores have been explained by electron beam induced softening of silica, which acts as a viscous fluid [35]. In the present case, elongated Au NPs in silica are fabricated by swift heavy ion irradiation and hence form during rapid quenching of transiently molten viscous fluid along ion track. Due to this they are not in a stable configuration because of the presence of interfacial stress. 200 keV electron beam irradiation leads to a temperature rise (140°C) of silica together with radiation enhanced diffusion of knocked-on O and Si atoms in silica, which acts as a viscous fluid. We believe the cumulative effects of electron beam induced heating, softening of silica matrix and RED of knock-on displaced O and Si atoms result in relaxation of stress around Au NPs driving their ellipsoidal-to-spherical shape transition for energy minimization.

Conclusion

In summary, an *in-situ* HRTEM study of electron-beam-induced shape evolution of elongated Au NPs embedded in SiO₂ matrix has been performed. Electron beam irradiation results in decrease in aspect ratio of elongated Au NPs, which can be controlled by irradiation time. The theoretical calculations indicate that the electron-beam irradiation leads to temperature rise (140°C) of silica matrix and knock-on displacements of O and Si atoms. The observed ellipsoidal-to-spherical shape transition of Au NPs embedded in silica can be ascribed to cumulative effects of electron beam induced heating, softening of silica matrix and RED of knock-on displaced O and Si atoms resulting in local stress relaxation.

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